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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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#### MOS FIELD EFFECT TRANSISTORS

## 2SK2359/2SK2360



# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK2359, 2SK2359-Z/2SK2360, 2SK2360-Z is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

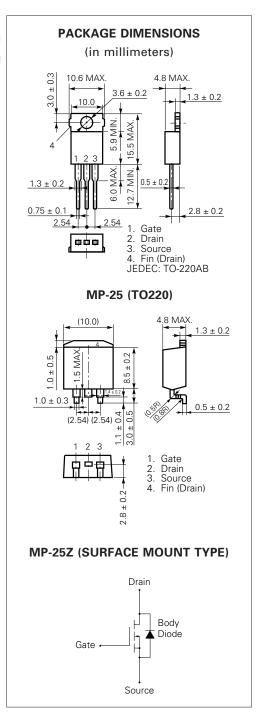
#### **FEATURES**

- · Low On-Resistance
  - 2SK2359:  $R_{DS(on)} = 0.9 \Omega$  (Vgs = 10 V, ID = 4.0 A) 2SK2360:  $R_{DS(on)} = 1.0 \Omega$  (Vgs = 10 V, ID = 4.0 A)
- Low Ciss Ciss = 1050 pF TYP.
- High Avalanche Capability Ratings

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

| Drain to Source Voltage(2SK2359/2SK2360)         | VDSS               | 450/500     | V  |
|--|--------------------|-------------|----|
| Gate to Source Voltage                           | Vgss               | ±30         | V  |
| Drain Current (DC)                               | ID(DC)             | ±7.0        | Α  |
| Drain Current (pulse)*                           | ID(pulse)          | ±28         | Α  |
| Total Power Dissipation (Tc = 25 °C)             | P <sub>T1</sub>    | 75          | W  |
| Total Power Dissipation (T <sub>A</sub> = 25 °C) | P <sub>T2</sub>    | 1.5         | W  |
| Channel Temperature                              | Tch                | 150         | °C |
| Storage Temperature                              | T <sub>stg</sub> · | -55 to +150 | °C |
| Single Avalanche Current**                       | las                | 7.0         | Α  |
| Single Avalanche Energy**                        | Eas                | 17          | mJ |
|  |                    |             |    |

- \* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- \*\* Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0



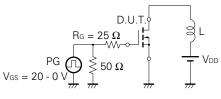


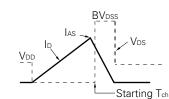


#### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

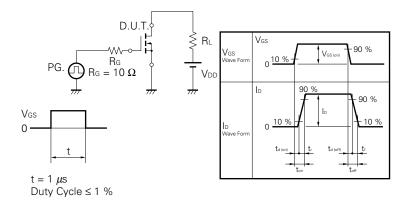
| CHARACTERISTIC                      | SYMBOL               | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS   |          |
|-------------------------------------|----------------------|------|------|------|------|---|----------|
| Drain to Source On-State Resistance | RDS(on)              |      | 0.7  | 0.9  | mΩ   | V <sub>GS</sub> = 10 V  | 2SK2359  |
|                                     |                      |      | 0.8  | 1.0  |      | V <sub>D</sub> = 4.0 V  | 2SK2360  |
| Gate to Source Cutoff Voltage       | V <sub>GS(off)</sub> | 2.5  |      | 3.5  | V    | $V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$                                   |          |
| Forward Transfer Admittance         | l yfs l              | 3.0  |      |      | S    | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 4.0 A                                  |          |
| Drain Leakage Current               | IDSS                 |      |      | 100  | μΑ   | $V_{DS} = V_{DSS}$ , $V_{GS} = 0$<br>$V_{GS} = \pm 30 \text{ V}$ , $V_{DS} = 0$ |          |
| Gate to Source Leakage Current      | Igss                 |      |      | ±100 | nA   |   |          |
| Input Capacitance                   | Ciss                 |      | 1050 |      | pF   | V <sub>DS</sub> = 10 V  |          |
| Output Capacitance                  | Coss                 |      | 200  |      | pF   | V <sub>GS</sub> = 0<br>f = 1 MHz  |          |
| Reverse Transfer Capacitance        | Crss                 |      | 26   |      | pF   |   |          |
| Turn-On Delay Time                  | td(on)               |      | 14   |      | ns   | ID = 4.0 A  |          |
| Rise Time                           | tr                   |      | 9    |      | ns   | V <sub>GS</sub> = 10 V<br>V <sub>DD</sub> = 150 V                               |          |
| Turn-Off Delay Time                 | td(off)              |      | 56   |      | ns   |   |          |
| Fall Time                           | tf                   |      | 14   |      | ns   | $R_G = 10 \Omega R_L$   | = 37.5 Ω |
| Total Gate Charge                   | QG                   |      | 27   |      | nC   | ID = 7.0 A  |          |
| Gate to Source Charge               | Qgs                  |      | 5.5  |      | nC   | V <sub>DD</sub> = 400 V   |          |
| Gate to Drain Charge                | Q <sub>GD</sub>      |      | 12   |      | nC   | Vgs = 10 V  |          |
| Body Diode Forward Voltage          | V <sub>F(S-D)</sub>  |      | 1.0  |      | V    | IF = 7.0 A, VGS   | = 0      |
| Reverse Recovery Time               | trr                  |      | 300  |      | ns   | IF = 7.0 A, VGS   | = 0      |
| Reverse Recovery Charge             | Qrr                  |      | 1.5  |      | μC   | di/dt = 50 A/μs   | 5        |

#### Test Circuit 1 Avalanche Capability

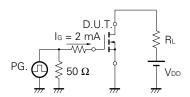




#### **Test Circuit 2 Switching Time**

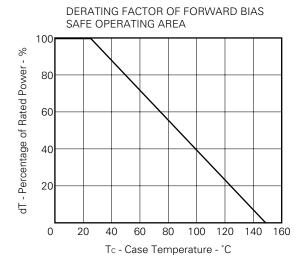


#### **Test Circuit 3 Gate Charge**

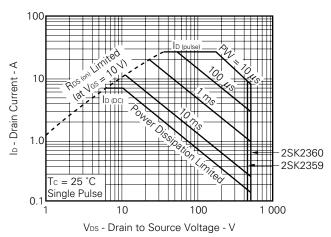


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

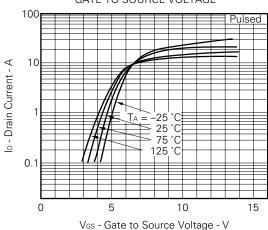
#### TYPICAL CHARACTERISTICS (TA = 25 °C)



#### FORWARD BIAS SAFE OPERATING AREA



DRAIN CURRENT vs.
GATE TO SOURCE VOLTAGE



TOTAL POWER DISSIPATION vs.
CASE TEMPERATURE

100

M - uotagissio 60

40

40

20

DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

80

Tc - Case Temperature - °C

100 120

140

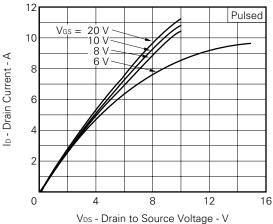
160

60

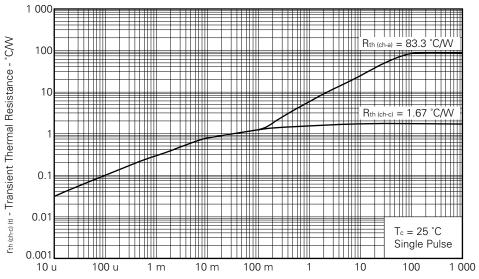
40

0

20

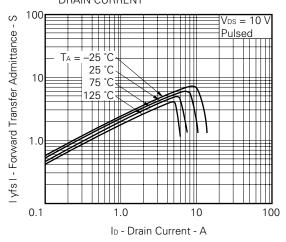




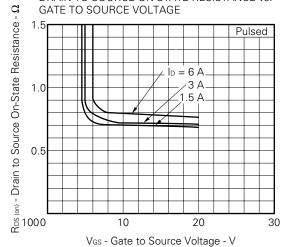


PW - Pulse Width - s

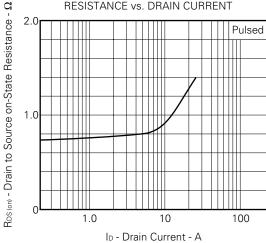
#### FORWARD TRANSFER ADMITTANCE vs. **DRAIN CURRENT**



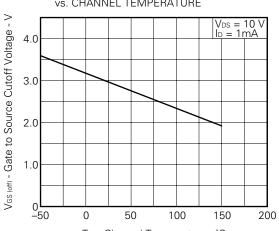
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



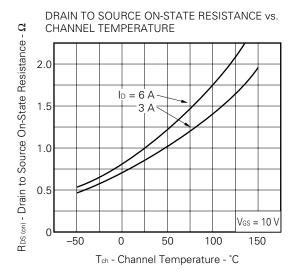
#### DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT 2.0

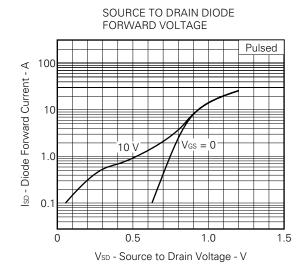


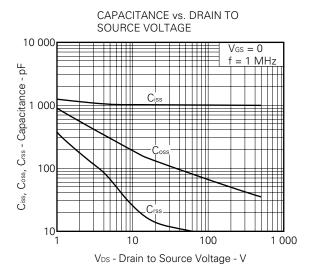
#### GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

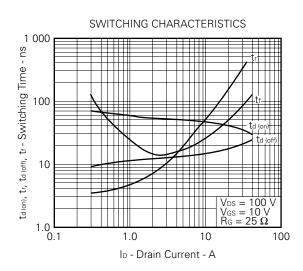


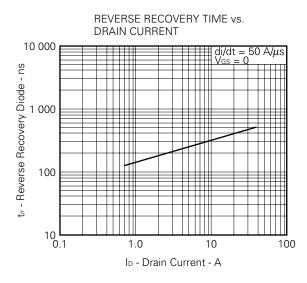
 $\mathsf{T}_\mathsf{ch}$  - Channel Temperature -  ${}^\circ\mathsf{C}$ 

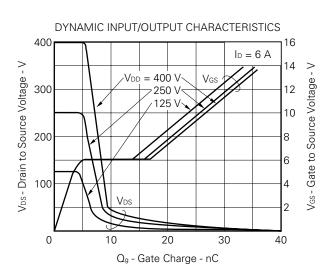




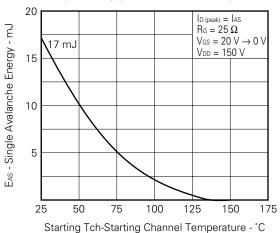




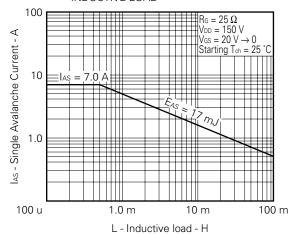




## SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



## SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD





#### **REFERENCE**

| Document Name  | Document No. |
|--|--------------|
| NEC semiconductor device reliability/quality control system.   | TEI-1202     |
| Quality grade on NEC semiconductor devices.                    | IEI-1209     |
| Semiconductor device mounting technology manual.               | IEI-1207     |
| Semiconductor device package manual.                           | IEI-1213     |
| Guide to quality assurance for semiconductor devices.          | MEI-1202     |
| Semiconductor selection guide.                                 | MF-1134      |
| Power MOS FET features and application switching power supply. | TEA-1034     |
| Application circuits using Power MOS FET.                      | TEA-1035     |
| Safe operating area of Power MOS FET.                          | TEA-1037     |

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



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